#### **AMP-LEAF**

TE Internal #: 583680-1

Housing, Receptacle, Wire-to-Board, 15 Position, .156 in [3.96 mm] Centerline, Crimp, 2 Row, Black, Mating Retention, Printed Circuit

Board

View on TE.com >



Connectors > PCB Connectors > Wire-to-Board Connectors > Wire-to-Board Connector Assemblies & Housings



Connector Product Type: Housing

Connector & Housing Type: Receptacle

Connector System: Wire-to-Board

Number of Positions: 15

Centerline (Pitch): 3.96 mm [ .156 in ]

#### **Features**

#### **Product Type Features**

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Connector Product Type	Housing
Connector & Housing Type	Receptacle
Connector System	Wire-to-Board
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Dual Positions	15
Number of Positions	15
Number of Rows	2
Electrical Characteristics	
Dielectric Withstanding Voltage (Max)	1800 VAC
Insulation Resistance	5000 ΜΩ
Body Features	
Primary Product Color	Black



#### **Contact Features**

Contact reatures	
Contact Current Rating (Max)	5 A
Termination Features	
Termination Method to Wire & Cable	Crimp
Mechanical Attachment	
Strain Relief	Without
Panel Mount Feature Type	Mounting Ears
Mating Retention	With
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	Polyester GF
Centerline (Pitch)	3.96 mm[.156 in]
Dimensions	
	.7 in
PCB Thickness (Recommended)	1.4 – 1.78 mm[.055 – .07 in]
Row-to-Row Spacing	4.14 mm[.163 in]
Usage Conditions	
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
Operation/Application	
Circuit Application	Power & Signal
Industry Standards	
Glow Wire Rating	Standard Part - Not Glow Wire
Packaging Features	
Packaging Features Packaging Quantity	225

# **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold



EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.

Product Compliance Disclaimer

Solder Process Capability

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts







# **Customers Also Bought**









Not applicable for solder process capability









#### **Documents**

#### **Product Drawings**

**HSG AMP LEAF 15 POS** 

English

#### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_583680-1\_T.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_583680-1\_T.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_583680-1\_T.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

### **Product Specifications**

**Product Specification** 

English

Connector, AMP-LEAF, .000030 Gold Plated Contacts, DPH Housing

English

**Product Specification** 

English

Connector, AMP-LEAF, Phenolic or Thermoplastic Housing

English

**Product Specification** 

English

Connector, AMP-LEAF, Tin Plated Contact

English

## **Agency Approvals**

**Agency Approval Document** 

English

Housing, Receptacle, Wire-to-Board, 15 Position, .156 in [3.96 mm] Centerline, Crimp, 2 Row, Black, Mating Retention, Printed Circuit Board



## Agency Approval Document

English